

### **General Description**

The MCP1703T-xx02E/DB family of a linear voltage linear regulators developed utilizing BM unique BiCMOS technology featured low quiescent current (90uA),low dropout voltage, high output voltage accuracy. The space-efficient SOT-223 package is attractive for "Pocket" and "HandHeld" applications.

Output voltages are set at the factory and trimmed to 1.5% accuracy. Voltages from 1.8V to 5.0V are available. These rugged devices have both Thermal Shutdown, and Current Fold-back to prevent device failure under the "Worst" of operating conditions.

The MCP1703T-xx02E/DB is stable with an output apacitance of 10 µF orgreater.

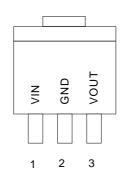
### **Features**

- ◆ Very Low Dropout Voltage , <800mV when 0.8A
- ◆ Low Current Consumption: Typ. 90uA
- ◆ High Accuracy Output Voltage: +/- 1.5%
- ◆ Guaranteed 0.8A (if Vin-Vout<1700mV in SOT223)
- ◆ Output up to 0.3A if down 12V to +5V in SOT223
- ◆ Compact Package: SOT-223
- ◆ Factory Pre-set Output Voltages
- ◆ Short Circuit Current Fold-Back
- ◆ Low Temperature Coefficient

## **Applications**

- Battery-powered devices
- Personal communication devices
- ♦ Home electric/electronic appliances
- PC peripherals , hard-disk

## **PIN Configuration**



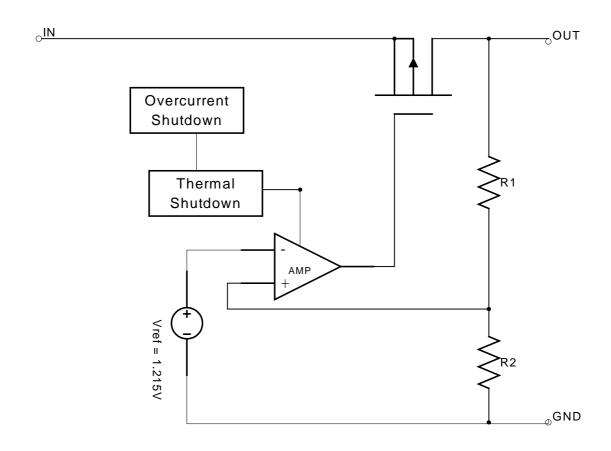


#### **Order Information**

Orderable Device	Orderable Device Package		Packing Option	
MCP1703T-xx02E/DB	SOT-223	2.5V,2.8V,3.0V,3.3V,5.0V	1000/Reel	

Note: xx is 25.28.30.33.50

# **Bkock Diagram**



# **Absolute Maximum Ratings**

Description	Symbol	Value Range	Unit
Input Voltage	VIN	+18	V
Output Current	lout	1.2	А
Output Voltage	Vout	GND-0.3 to V <sub>IN</sub> +0.3	V
ESD Classification		В	



## **Operating Ratings**

Description	Symbol	Value Range	Unit
Supply Voltage	Vin	+2 to +16	V
Ambient Temperature Range	Та	-40 to +85	$^{\circ}$
Junction Temperature Range	T <sub>J</sub>	-40 to +125	${\mathbb C}$

### **Thermal Information**

Parameter	Maximum	Unit
Thermal Resistance ( $\Theta_{jc}$ )	160	°C/W
Internal Power Dissipation ( $P_D$ ) ( $\Delta T = 100^{\circ}C$ )	625	mW
Maximum Junction Temperature	150	$^{\circ}\!\mathbb{C}$
Maximum Lead Temperature (10 Sec)	300	$^{\circ}\!\mathbb{C}$

\*With Junction sink capable of twice times of  $\Theta_{jc}$  Caution: Stress above the listed absolute rating may cause permanent damage to the device.

### **Electrical Characteristics**

 $T_A = +25^{\circ}C$ ; unless otherwise noted

Danamatan	C: mala al	Test Conditions		MCP1703T-xx02E/DB			11:4	
Parameter	Symbol			Min.	Тур.	Max.	Unit	
Input Voltage	$V_{IN}$			+2		+18	V	
Output Voltage Accuracy	V <sub>OUT</sub>	I <sub>O</sub> = 1mA to 1.5A		-1.5		1.5	%	
	V <sub>DROPOUT</sub>	V <sub>OUT</sub> =V <sub>O(NOM)</sub> -4%,	lout=0.8A	700			m\/	
Dropout Voltage			Iout=600mA			700	mV	
			Iout=100mA			200	mV	
Output Current	Io	V <sub>OUT</sub> >	1.5V		800		mA	
Current Limit	I <sub>LIM</sub>	V <sub>OUT</sub> >	1.5V		1200		mA	
Short Circuit Current	I <sub>SC</sub>	V <sub>OUT</sub> <	0.4V		750	1200	mA	
Quiescent Current	ΙQ	$I_{O} = 0$	mA		90		uA	
Ground Pin Current	I <sub>GND</sub>	$I_{O} = 1 \text{mA}$	to 1A		90		uA	
Line Degulation	DEO	Ι	V <sub>OUT</sub> <= 4.0V			1.5	%	
Line Regulation	REG <sub>LINE</sub>	I <sub>OUT</sub> =5mA	V <sub>OUT</sub> > 4.0V		2		%	
Load Regulation	REG <sub>LOAD</sub>	I <sub>O</sub> = 0 ~ 0	I <sub>O</sub> = 0 ~ 0.8A		0.2	1.5	%	
Over Temperature Shutdown	OTS				150		°C	
Over Temperature Hystersis	OTH				30		°C	
V <sub>OUT</sub> Temperature Coefficient	TC				30		ppm/°C	
			f=1kHz		72			
Power Supply Reject	PSRR	$I_0 = 100$ mA $C_0 = 22$ µF ceramic	f=10kHz		60		dB	
			f=100kHz		45			
Outsid Vallage Naise	- N I	f=10Hz to 100kHz	C <sub>O</sub> =22µF		30			
Output Voltage Noise	eN	$I_{O} = 10 \text{mA}$ $C_{O} = 47 \mu \text{F}$			20		$\mu$ Vrms	

Note 1. V<sub>IN(MIN)</sub> = V<sub>OUT</sub> + V<sub>DROPOUT</sub>

### **Detailed Description**

The MCP1703T-xx02E/DB family of BiCMOS regulators contain a pass transistor, voltage reference, error amplifier, over-current protection, thermal shutdown, and short circuit protection.

The P-channel pass transistor receives data from the error amplifier, over-current shutdown, short output protection, and thermal protection circuits. During normal operation, the error amplifier compares the output voltage to a precision reference. Over-current and Thermal shutdown circuits become active when the junction temperature exceeds 150°C, or the current exceeds 1.2A. During thermal shutdown the output voltage remains lowNormal operation is restored when the junction temperature drops below 120°C.

The MCP1703T-xx02E/DB behaves like a current source when the load reaches 1.2A. However, if the load impedance drops below  $0.3\Omega$ , the current drops back to 600mA to prevent excessive power dissipation. Normal operation is restored when the load resistance exceeds  $0.75\Omega$ .

## **External Capacitor**

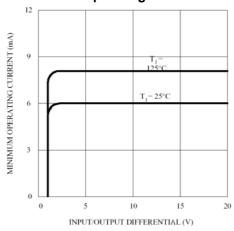
The MCP1703T-xx02E/DB is stable with an output capacitor to ground of  $22\mu\text{F}$  or greater. Ceramic capacitors have the lowest ESR, and will offer the best AC performance. Conversely, Aluminum Electrolytic capacitors exhibit the highest ESR, resulting in the poorest AC response. Unfortunately, large value ceramic capacitors are comparatively expensive. One option is to parallel a  $0.1\mu\text{F}$  ceramic capacitor with a  $22\mu\text{F}$  Aluminum Electrolytic. The benefit is low ESR, high capacitance, and low overall cost.

A second capacitor is recommended between the input and ground to stabilize VIN. The input capacitor should be larger than 22µF to have a beneficial effect. All capacitors should be placed in close proximity to the pins. A "quiet" ground termination is desirable.

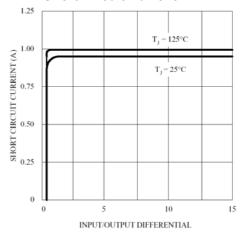


## **Typical Electrical Characteristics**

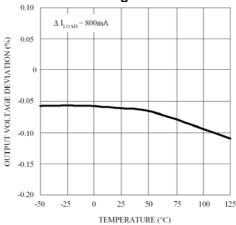
### **Minimum Operating Current**



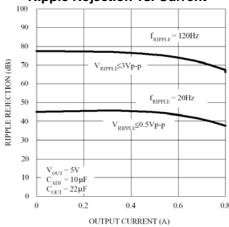
#### **Short-Circuit Current**



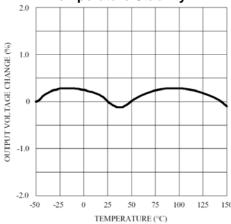
#### **Load Regulation**



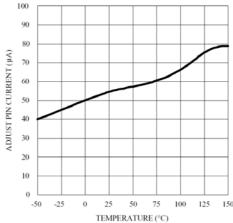
### Ripple Rejection vs. Current



### Temperature Stability



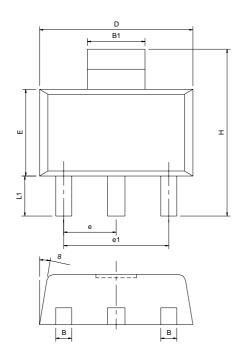
## **GND Pin Current**

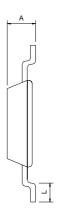




# **Package Dimension**

## SOT-223 (M223)





SYMBOLS	DIMENSIO	NS IN MIL	IMETERS	DIMENSIONS IN INCHS		
SIMBOLS	MIN	NOM	MAX	MIN	NOM	MAX
A	1.50		1.80	0.0591		0.0709
В	0.60		0.838	0.0236		0.033
B1	2.895		3.15	0.114		0.124
D	6.299		6.706	0.248		0.264
E	3.30		3.708	0.1299		0.146
e		2.30BSC			0.09BSC	
e1		4.60BSC			0.181BSC	
н	6.70		7.30	0.2638		0.2874
L		0.91MIN			0.036MIN	
L1		XAMOO.S			0.0787MAX	
θ			13°			13°



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